

TO-252 Pin Configuration

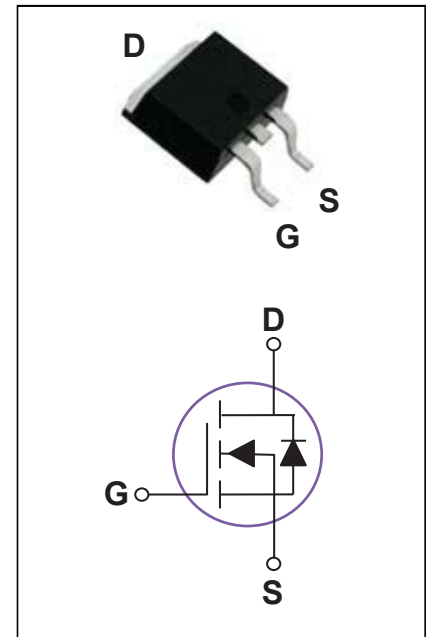
BVDSS	R _{DS(on)}	I _D
30V	6mΩ	80A

FEATURES

- 30V, 80A, R_{DS(ON)} = 6mΩ @ V_{GS} = 10V
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

APPLICATIONS

- MB / VGA / Vcore
- POL Applications
- SMPS 2nd SR



MAXIMUM RATINGS AND CHARACTERISTICS

@ 25°C Ambient Temperature (unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current – Continuous (T _C =25°C)	I _D	80	A
Drain Current – Continuous (T _C =100°C)		51	A
Drain Current – Pulsed ¹	I _{DM}	320	A
Single Pulse Avalanche Energy ²	EAS	88	mJ
Single Pulse Avalanche Current ²	I _{AS}	42	A
Power Dissipation (T _C =25°C)	PD	54	W
Power Dissipation – Derate above 25°C		0.43	W/°C
Storage Temperature Range	T _{STG}	-55 to +150	°C
Operating Junction Temperature Range	T _J	-55 to +150	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Unit
Thermal Resistance Junction to ambient	R _{θJA}	---	62	°C/W
Thermal Resistance Junction to Case	R _{θJC}	---	2.3	°C/W

MOSFET ELECTRICAL CHARACTERISTICS T_A=25°C unless otherwise specified

Off Characteristics

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	30	---	---	V
BV _{DSS} Temperature Coefficient	ΔBV _{DSS} /ΔT _J	Reference to 25°C, I _D =1mA	---	0.04	---	
Drain-Source Leakage Current	I _{DSS}	V _{DS} =30V, V _{GS} =0V, T _J =25°C	---	---	1	uA
		V _{DS} =24V, V _{GS} =0V, T _J =125°C	---	---	10	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	---	---	±100	nA
Static Drain-Source On-Resistance ³	R _{DS(ON)}	V _{GS} =10V, I _D =20A	---	4.8	6	mΩ
		V _{GS} =4.5V, I _D =10A	---	6.5	9	mΩ
Gate Threshold Voltage	V _{GS(th)}	V _{GS} =V _{DS} , I _D =250uA	1	1.6	2.5	V
V _{GS(th)} Temperature Coefficient	ΔV _{GS(th)}		---	-4	---	mV/°C
Forward Transconductance	g _{fs}	V _{DS} =10V, I _D =10A	---	18	---	S

Dynamic Characteristics

Total Gate Charge ^{3,4}	Q _g	V _{DS} =15V, V _{GS} =4.5V, I _D =20A	---	11.1	---	nC
Gate-Source Charge ^{3,4}	Q _{gs}		---	1.85	---	
Gate-Drain Charge ^{3,4}	Q _{gd}		---	6.8	---	
Turn-On Delay Time ^{3,4}	T _{d(on)}	V _{DD} =15V, V _{GS} =10V, R _G =3.3Ω, I _D =15A	---	7.5	---	ns
Rise Time ^{3,4}	T _r		---	14.5	---	
Turn-Off Delay Time ^{3,4}	T _{d(off)}		---	35.2	---	
Fall Time ^{3,4}	T _f		---	9.6	---	
Input Capacitance	C _{iss}	V _{DS} =25V, V _{GS} =0V, F=1MHz	---	1160	---	pF
Output Capacitance	C _{oss}		---	200	---	
Reverse Transfer Capacitance	C _{rss}		---	180	---	
Gate resistance	R _g	V _{GS} =0V, V _{DS} =0V, F=1MHz	---	2.5	---	Ω

Guaranteed Avalanche Energy

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Single Pulse Avalanche Energy	EAS	V _{DD} =25V, L=0.1mH, I _{AS} =20A	20	---	---	mJ

Drain-Source Diode Characteristics

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	I _S	V _G =V _D =0V, Force Current	---	---	80	A
Pulsed Source Current ³	I _{SM}		---	---	320	A
Diode Forward Voltage ³	V _{SD}	V _{GS} =0V, I _S =1A, T _J =25°C	---	---	1	V
Reverse Recovery Time	t _{rr}	V _{GS} =0V, I _S =1A, di/dt=100A/μs T _J =25°C	---	---	---	ns
Reverse Recovery Charge	Q _{rr}		---	---	---	nC

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_{AS}=42A, R_G=25Ω, Starting T_J=25°C.
3. The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%.
4. Essentially independent of operating temperature.

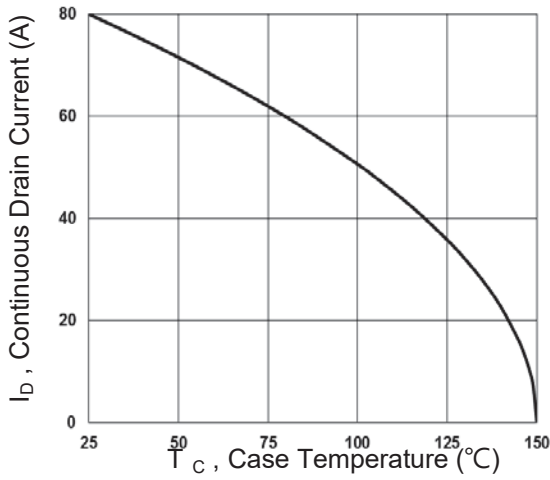


Fig.1 Continuous Drain Current vs. T_c

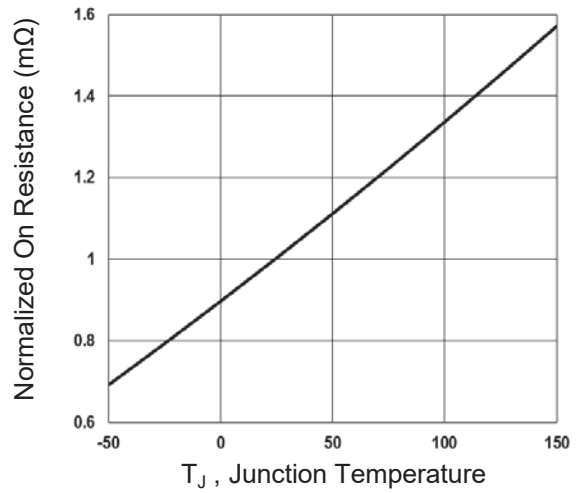


Fig.2 Normalized RDSON vs. T_j

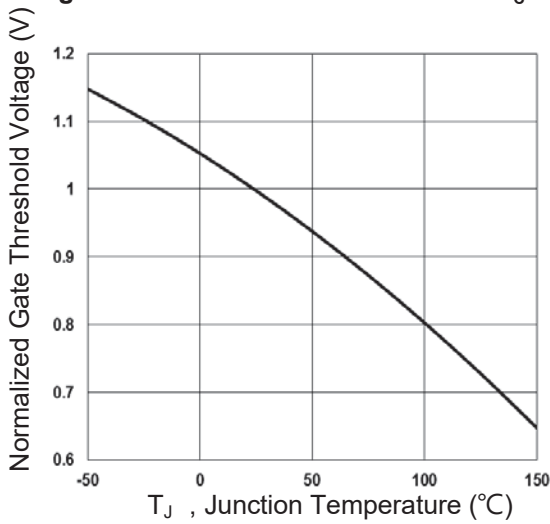


Fig.3 Normalized V_{th} vs. T_j

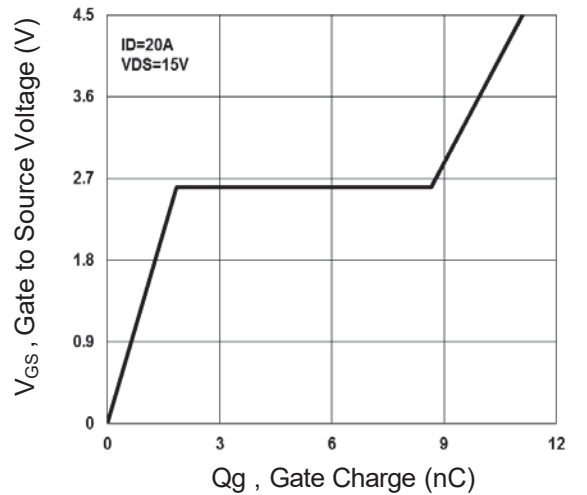


Fig.4 Gate Charge Waveform

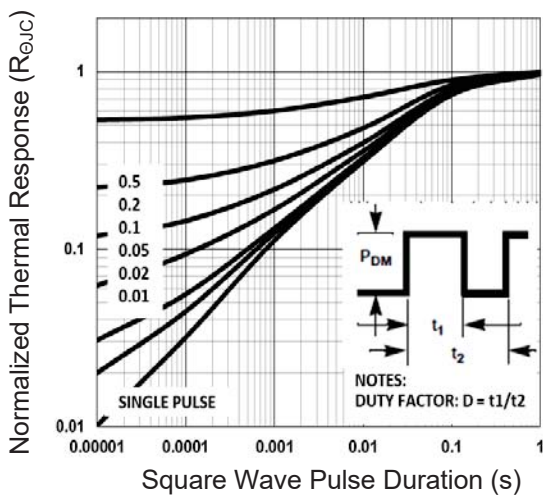


Fig.5 Normalized Transient Impedance

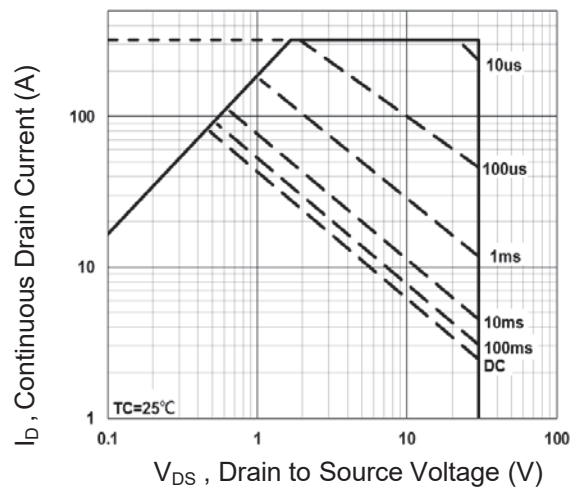


Fig.6 Maximum Safe Operation Area

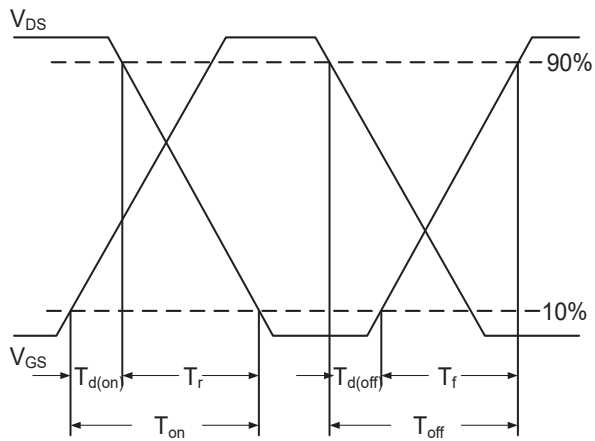


Fig.7 Switching Time Waveform

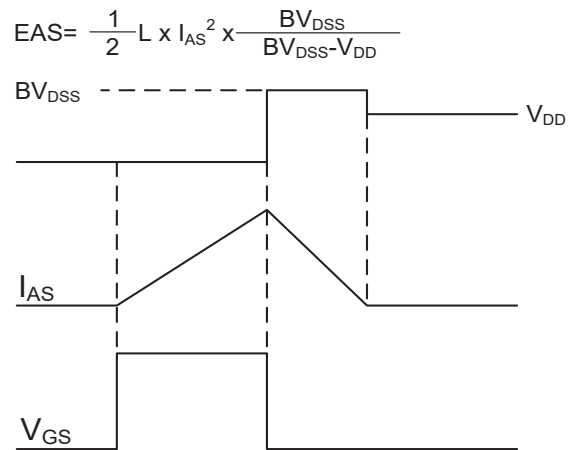
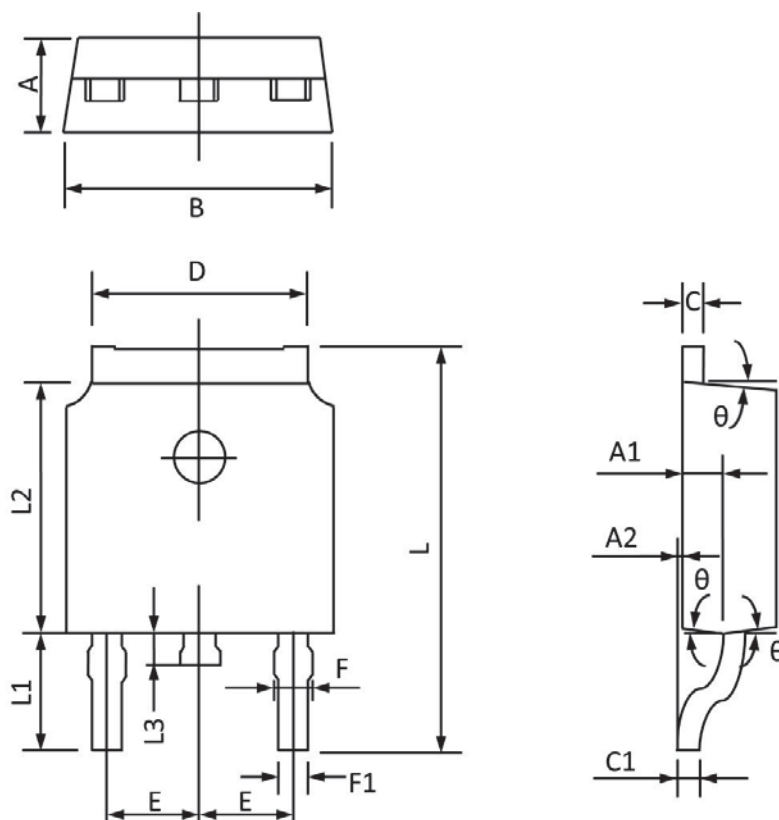


Fig.8 EAS Waveform

TO-252 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	2.20	2.40	0.087	0.094
A1	0.91	1.11	0.036	0.044
A2	0.00	0.15	0.000	0.006
B	6.50	6.70	0.256	0.264
C	0.46	0.580	0.018	0.230
C1	0.46	0.580	0.018	0.030
D	5.10	5.46	0.201	0.215
E	2.186	2.386	0.086	0.094
F	0.74	0.94	0.029	0.037
F1	0.660	0.860	0.026	0.034
L	9.80	10.40	0.386	0.409
L1	2.9REF		0.114REF	
L2	6.00	6.20	0.236	0.244
L3	0.60	1.00	0.024	0.039
θ	3°	9°	3°	9°